

DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled "METHODS OF SELECTIVELY BUMPING INTEGRATED CIRCUIT SUBSTRATES AND RELATED STRUCTURES," the specification of which

	-		
is attached hereto	•		
OR			•
was filed on	as United S	or PCT	
International Applica	ation Number	and was amended on	(if applicable).
I hereby state that I h specification, including above.	ave reviewed and uing the claims, as an	nderstand the contents of the nended by any amendment	he above-identified specifically referred to
37 C.F.R. § 1.56, income available bet	cluding for continuative tween the filing date	mation which is material to tion-in-part applications, me of the prior application and ion-in-part application.	o patentability as defined in naterial information that nd the national or PCT
foreign application(s of any PCT internati United States of Am for patent, inventor's	 for patent, inventogonal application where errors is the contract of the contract	or's or plant breeder's rights ich designated at least one	country other than the low any foreign application PCT international
			☐ Yes ☐ No
Number	Country	MM/DD/YYYY Filed	Priority Claimed
			☐ Yes ☐ No
Number	Country	MM/DD/YYYY Filed	Priority Claimed
			Yes No
Number	Country	MM/DD/YYYY Filed	Priority Claimed

I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below.

60/448,096	02/18/2003	
Application Number(s)	Filing Date (MM/DD/YYYY)	
Application Number(s)	Filing Date (MM/DD/YYYY)	

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s) or § 365(c) of any PCT international application designating the United States of America, listed below.

Application No.	Filing Date	Status Patented/Pending/Abandoned
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following registered attorney(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. I also appoint the following registered attorney(s) to represent me before all competent International Authorities in connection with any and all international applications filed by me with an appropriate receiving office claiming priority to the U.S. application. I also appoint the following registered attorney(s) to make or receive payment on my behalf in connection with the filing of such international applications.

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